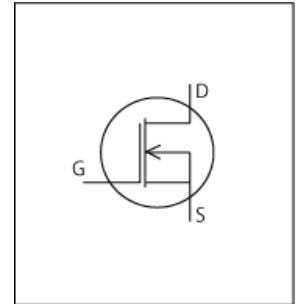


# LTspice Model

## NMOS

## TI

## CSD17313Q2



### Model Information

**Model** A macro model based on BSIM3 model  
**Call Name** MDC\_CSD17313Q2\_LT  
**Pin Assign** 1:D 2:D 3:G 4:S 5:D 6:D  
**File List** Model Library MDC\_CSD17313Q2\_LT01.lib  
 Model Report MDC\_CSD17313Q2\_LT.pdf (this file)

**Verified Simulator Version** LTspice version XVII  
**Note**

### References

The information which was used for modeling is as follow:

[Data Sheet]

- Date/Version REVISED SEPTEMBER 2015
- Product name CSD17313Q2
- Company name Texas Instruments Inc.
- Characteristics IdVds[Vgs], IdVgs[Temp], VgsQg[Vdd], CapacitanceVds[Cname], VthTemp[Id], Rds(on)Vgs[Temp], Rds(on)Temp[Vgs], Rds(on)Temp[Vgs]02, IsVsd[Temp], SwitchingIdd[Tname], Switching Waveform, Trrlf[Ir], Qrrlf[Ir], TrrQrrWaveform

### Simulation Range

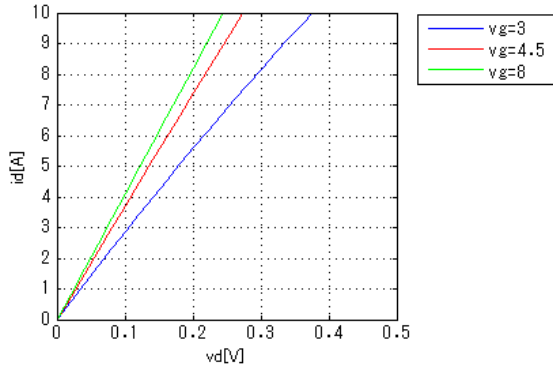
This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Range			Unit
	Min.		Max.	
Drain-source voltage (DC)	0	to	30	V
Gate-source voltage (DC)	-8	to	10	V
Temperature	-55	to	150	deg C

Simulation results are following.  
 Explanatory notes — : simulated

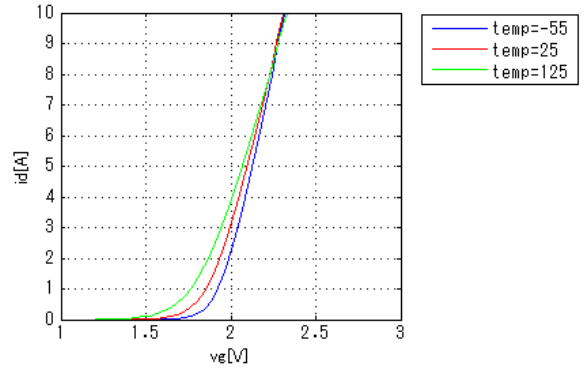
**IdVds[Vgs]**

Temp. = 25degC



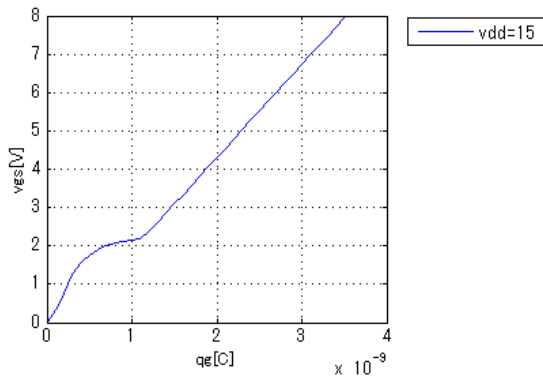
**IdVgs[Temp]**

Vds = 5V



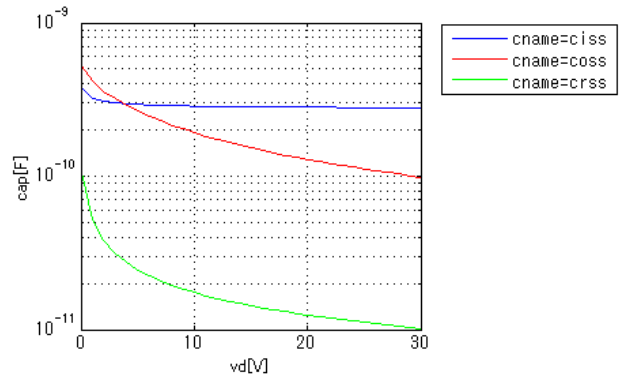
**VgsQg[Vdd]**

Id = 4A



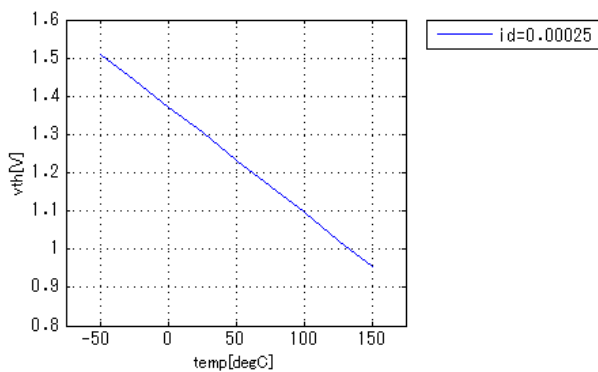
**CapacitanceVds[Cname]**

freq = 1000000Hz



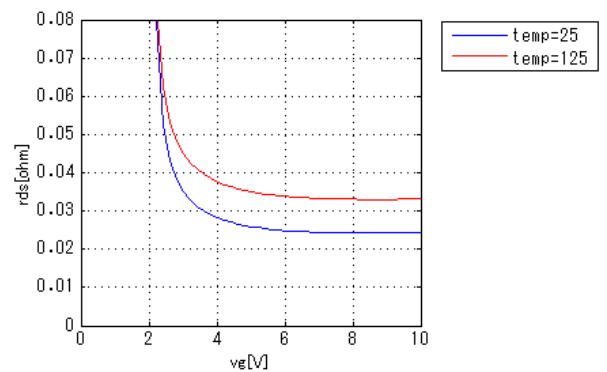
**VthTemp[Id]**

Vd = Vg



**Rds(on)Vgs[Temp]**

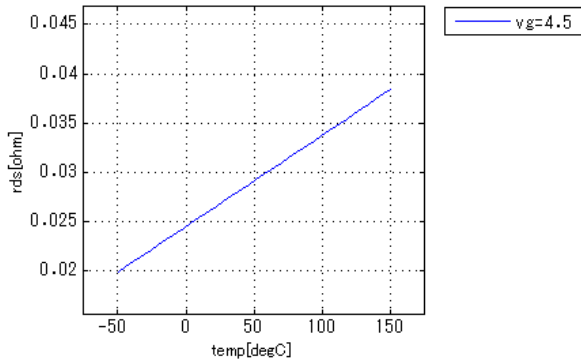
Id = 4A



Simulation results are following.  
 Explanatory notes — : simulated

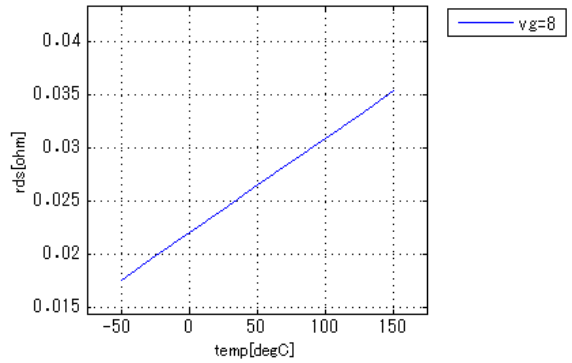
**Rds(on)Temp[Vgs]**

Id = 4A

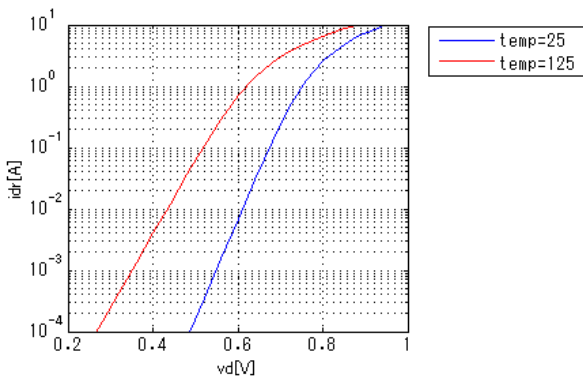


**Rds(on)Temp[Vgs]02**

Id = 4A

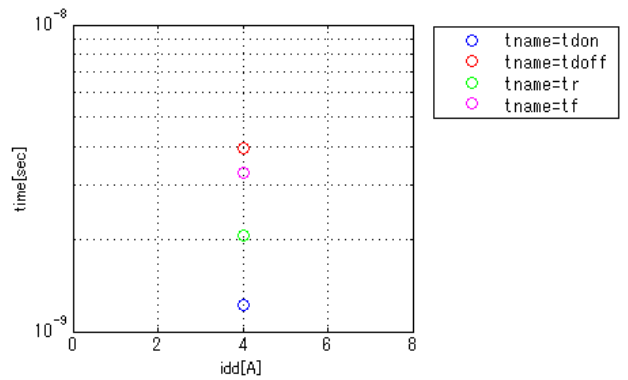


**IsVsd[Temp]**



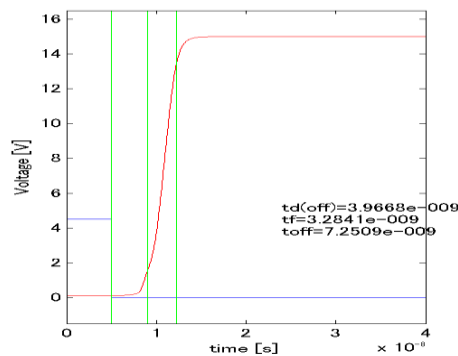
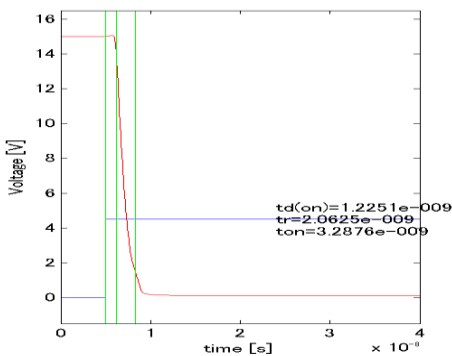
**SwitchingIdd[Tname]**

vgg = 4.5V, vdd = 15V, RGG = 2.0ohm



**SwitchingWaveform**

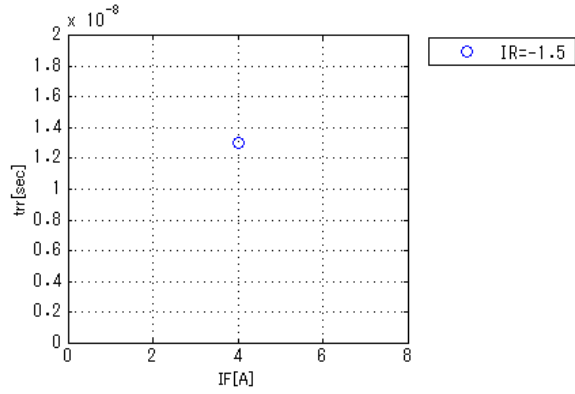
Blue : INPUT Red : OUTPUT



Simulation results are following.  
 Explanatory notes — : simulated

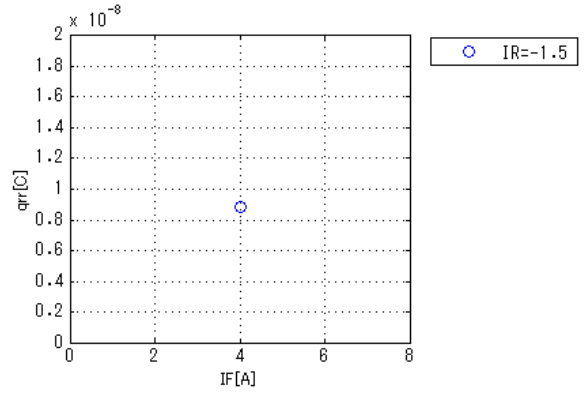
**Trrlf[Ir]**

vdd = 13.5V, didt = 300A/us

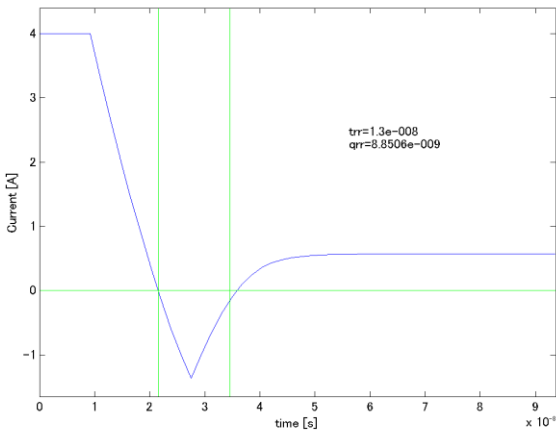


**Qrrlf[Ir]**

vdd = 13.5V, didt = 300A/us



**TrrQrrWaveform**



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